



# **5-TVS/ZENER ARRAY FOR ESD AND LATCH-UP PROTECTION**

This 5-TVS array has been designed to Protect Sensitive Equipment against ESD and to prevent Latch-Up events in CMOS circuitry, operating at 3.3V and 5V Systems. This TVS array offers an integrated solution to protect up to 5 data lines where the board space is a premium.

### **SPECIFICATION FEATURES**

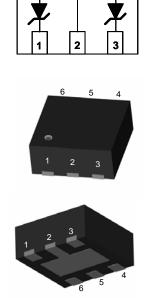
- 15W Power Dissipation (8/20µs Waveform)
- Low Leakage Current, Maximum of 0.5µA @ VWRM
- Very low Off-State Capacitance, Maximum of 10pF at 1MHz 0Vdc
- IEC61000-4-2 ESD 20kV air, 15kV Contact Compliance
- 100% Tin plated finish (LEAD FREE) RoHS Compliant
- New SMT package QFN 1.6mm x 1.6mm; Max Height of 0.75mm
- Same Footprint compared to the SOT563

#### **APPLICATIONS**

- Personal Digital Assistant (PDA)
- MP3 Players
- Portable Global positioning Systems Port
- Mobile Phones and Accessories
- Memory Card Port Protection

#### MAXIMUM RATINGS (Per Device)





QFN 1.6x1.6 sq mm Package

Rating	Symbol	Value	Units
Peak Pulse Power (8/20µs Waveform)	P <sub>pp</sub>	15	W
ESD Voltage (HBM)	V <sub>ESD</sub>	>25	kV
Operating Temperature Range	ТJ	-55 to +150	°C
Storage Temperature Range	T <sub>stg</sub>	-55 to +150	°V

## ELECTRICAL CHARACTERISTICS (Per Device) Tj = 25°C

## PJESD5V6LCQ5G

Parameter	Symbol	Conditions	Min	Typical	Max	Units
Reverse Stand-Off Voltage	V <sub>WRM</sub>				3.3	V
Reverse Breakdown Voltage	$V_{BR}$	I <sub>BR</sub> =1mA	5.3	5.6	5.88	V
Reverse Leakage Current	۱ <sub>R</sub>	V <sub>R</sub> = 3.3V			0.5	μA
Clamping Voltage (8/20µs)	Vc	I <sub>pp</sub> =1 A			7.0	V
Clamping Voltage (8/20µs)	Vc	I <sub>pp</sub> = 2 A			8.0	V
Off State Junction Capacitance	Cj	0 Vdc Bias f = 1MHz Between I/O pins and pin 2		9.6	10	pF
Off State Junction Capacitance	Cj	3.3 Vdc Bias f = 1MHz Between I/O pins and pin 2		6.2	8	pF

# PJESD5V6LCQ5G Series

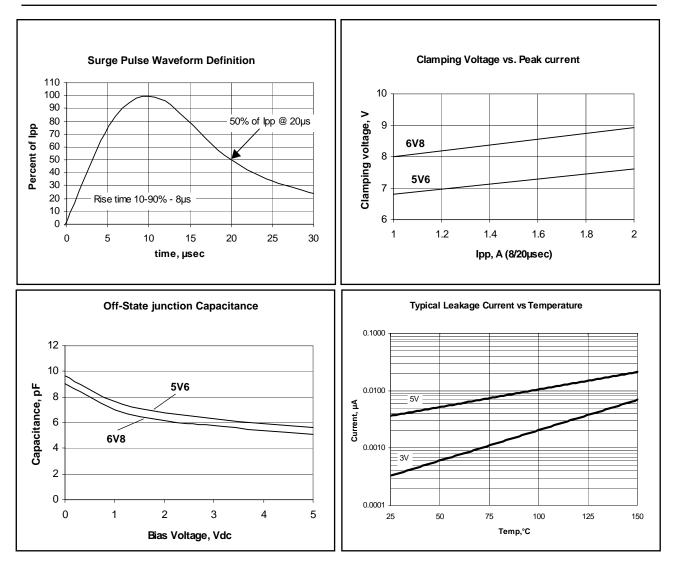


## ELECTRICAL CHARACTERISTICS (Per Device) Tj = 25°C

# PJESD6V8LCQ5G

Parameter	Symbol	Conditions	Min	Typical	Max	Units
Reverse Stand-Off Voltage	V <sub>WRM</sub>				5.0	V
Reverse Breakdown Voltage	V <sub>BR</sub>	I <sub>BR</sub> =1mA	6.2	6.8	7.2	V
Reverse Leakage Current	۱ <sub>R</sub>	V <sub>R</sub> =5.0V			0.5	μA
Clamping Voltage (8/20µs)	Vc	I <sub>pp</sub> = 1 A			9	V
Clamping Voltage (8/20µs)	Vc	I <sub>pp</sub> = 2 A			10	V
Off State Junction Capacitance	Cj	0 Vdc Bias f = 1MHz Between I/O pins and pin 2		9.1	10	pF
Off State Junction Capacitance	Cj	5 Vdc Bias f = 1MHz Between I/O pins and pin 2		5.0	6	pF

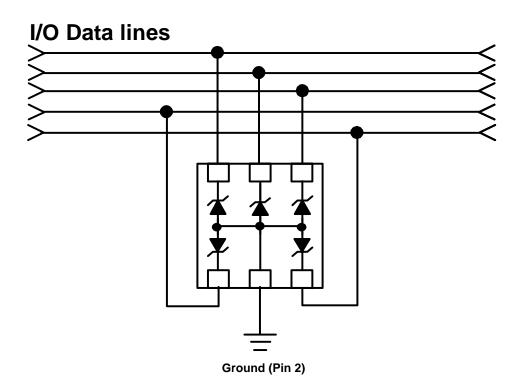
## TYPICAL CHARACTERISTICS 25°C unless otherwise noted







## TYPICAL APPLICATION EXAMPLE



## Marking Code Information

Device	Marking Code
PJESD5V6LCQ5G	QE
PJESD6V8LCQ5G	QG

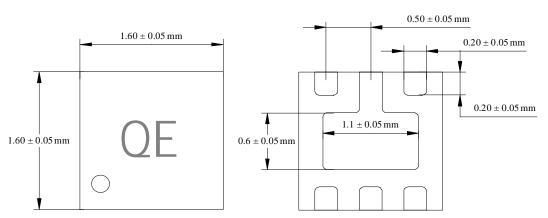




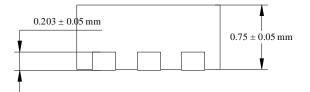
## PACKAGE DIMENSIONS AND SUGGESTED BOND PAD LAYOUT

**TOP VIEW** 

#### **BOTTOM VIEW**

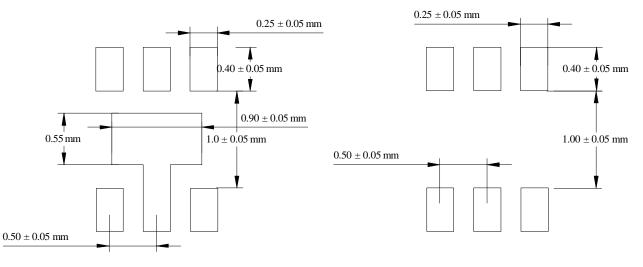


SIDE VIEW



PREFERRED

ALTERNATE



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